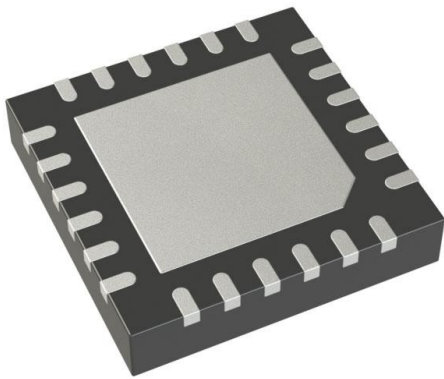


PL607041UMG Datasheet

www.digi-electronics.com



<https://www.DiGi-Electronics.com>

| | |
|------------------------------|--------------------------------------|
| DiGi Electronics Part Number | PL607041UMG-DG |
| Manufacturer | Microchip Technology |
| Manufacturer Product Number | PL607041UMG |
| Description | IC CLK SYNTHESIZER DUAL 44QFN |
| Detailed Description | IC 200MHz 1 24-VFQFN Exposed Pad |



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.

Purchase and inquiry

Manufacturer Product Number:

PL607041UMG

Series:

ClockWorks®

DiGi-Electronics Programmable:

Not Verified

Input:

Clock, Crystal

Number of Circuits:

1

Differential - Input:Output:

No/Yes

Divider/Multiplier:

No/No

Operating Temperature:

-40°C ~ 85°C

Package / Case:

24-VFQFN Exposed Pad

Base Product Number:

PL607041

Manufacturer:

Microchip Technology

Product Status:

Active

PLL:

Yes

Output:

HCSL

Ratio - Input:Output:

1:4

Frequency - Max:

200MHz

Voltage - Supply:

2.375V ~ 3.465V

Mounting Type:

Surface Mount

Supplier Device Package:

24-QFN (4x4)

Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8542.39.0001

Moisture Sensitivity Level (MSL):

2 (1 Year)

ECCN:

EAR99

PL607041
**ClockWorks® PCIe Quad Outputs
Ultra-Low Jitter, HCSL Frequency
Synthesizer**

General Description

The PL607041 is a member of the ClockWorks® family of devices from Micrel and provides an extremely low-noise Spread-Spectrum clock for PCI Express requirements.

The device operates from a 3.3V or 2.5V power supply and synthesizes four HCSL output clocks at 25MHz, 100MHz, 125MHz, and 200MHz. The PL607041 accepts a 25MHz crystal.

Datasheets and support documentation are available on Micrel's web site at: www.micrel.com.

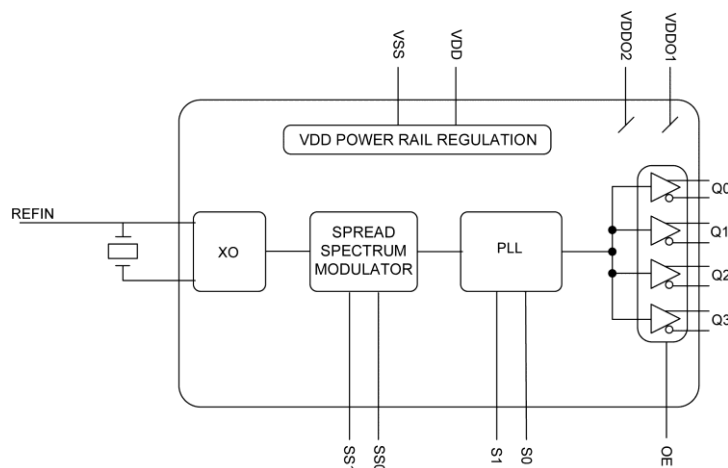
Features

- 25MHz fundamental crystal or reference input
- Generates four HCSL clock outputs at 25MHz, 100MHz, 125MHz, and 200MHz
- Spread spectrum for EMI reduction
- 2.5V or 3.3V operating range
- Typical phase jitter @ 100MHz (1.5MHz to 10MHz): 320fs
- Compliant with PCI Express Gen1, Gen2, and Gen3
- Industrial temperature range (–40°C to +85°C)
- RoHS and PFOS compliant
- Available in 24-pin 4mm x 4mm QFN package

Applications

- Servers
- Storage systems
- Switches and routers
- Gigabit Ethernet
- Set-top boxes/DVRs

Block Diagram



ClockWorks is a registered trademark of Micrel, Inc.

Ripple Blocker is a trademark of Micrel, Inc.

Micrel Inc. • 2180 Fortune Drive • San Jose, CA 95131 • USA • tel +1 (408) 944-0800 • fax + 1 (408) 474-1000 • <http://www.micrel.com>

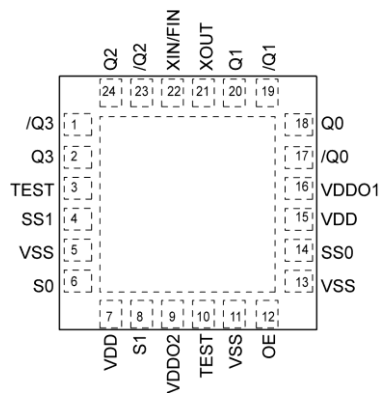
Ordering Information⁽¹⁾

| Part Number | Marking | Shipping | Junction Temperature Range | Package |
|----------------|--------------|---------------|----------------------------|------------|
| PL607041UMG | PL607 041 | Tube | -40° to +85°C | 24-Pin QFN |
| PL607041UMG TR | PL607 041 | Tape and Reel | -40° to +85°C | 24-Pin QFN |

Note:

1. Devices are RoHS and PFOS compliant.

Pin Configuration



**24-Pin QFN
(Top View)**

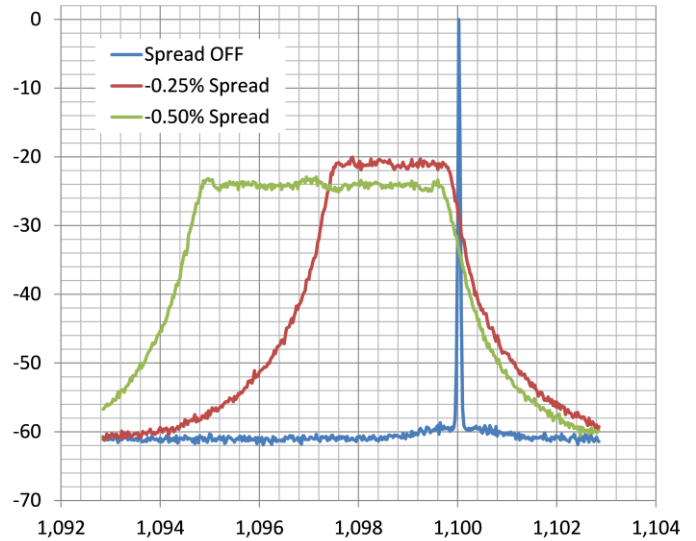
Pin Description

| Pin Number | Pin Name | Pin Type | Pin Level | Pin Function |
|------------------|--------------------|----------|-----------|--|
| 17, 18 19, 20 | /Q0, Q0 /Q1, Q1 | O, (DIF) | HCSL | Differential Clock Outputs pins. |
| 23, 24 1, 2 | /Q2, Q2 /Q3, Q3 | O, (DIF) | HCSL | Differential Clock Outputs pins. |
| 9 | VDDO2 | PWR | | Power Supply. |
| 16 | VDDO1 | PWR | | Power Supply. |
| 7, 15 | VDD | PWR | | Core Power Supply. |
| 5, 11, 13 | VSS | PWR | | Power Supply Ground. |
| 6, 8 | S0, S1 | I | LVC MOS | Frequency Select for 25MHz, 100MHz, 125MHz, and 200MHz. Each pin has a 45kΩ pull-up. |
| 14, 4 | SS0, SS1 | I | LVC MOS | Spread Spectrum Select pins. Each pin has a 60kΩ pull-up. |
| 22 | XIN/FIN | I, (SE) | Crystal | Crystal or Reference Input, no load caps needed (see Figure 5). |
| 21 | XOUT | O, (SE) | Crystal | Crystal Output, no load caps needed (see Figure 5). |
| 12 | OE | I, (SE) | LVC MOS | Output Enable/Disable. |
| 3, 10 | TEST | I | | Factory test pins. Keep these pins floating. |

EMI Reduction

The Spread Spectrum modulation causes the emission of spectral components in the clock signal to be reduced. The spectrum plot on the right shows measurement results with the two spread settings versus no spread. This plot is looking at the 11th harmonic in a 100MHz clock, at 1.1GHz. The scale is normalized to the strength of this spur without spread. The plot shows about 21dB reduction for -0.25% spread magnitude and 24dB for -0.50% spread magnitude.

The plot also shows how the frequency spreading is happening downwards.



Absolute Maximum Ratings⁽²⁾

| | |
|---|---------------------------|
| Supply Voltage (V_{DD} , $V_{DDO1/2}$)..... | +4.6V |
| Input Voltage (V_{IN})..... | -0.50V to $V_{DD} + 0.5V$ |
| Lead Temperature (soldering, 20s)..... | 260°C |
| Case Temperature | 115°C |
| Storage Temperature (T_s)..... | -65°C to +150°C |

Operating Ratings⁽³⁾

| | |
|--|--------------------|
| Supply Voltage (V_{IN})..... | +2.375V to +3.465V |
| Ambient Temperature (T_A) | -40°C to +85°C |
| Junction Thermal Resistance ⁽⁴⁾ | |
| QFN (θ_{JA}) | 50°C/W |
| QFN (ψ_{JB})..... | 30°C/W |

Electrical Characteristics⁽⁵⁾

$V_{DD} = V_{DDO1/2} = 3.3V \pm 5\%$ or $2.5V \pm 5\%$

$V_{DD} = 3.3V \pm 5\%$, $V_{DDO1/2} = 3.3V \pm 5\%$ or $2.5V \pm 5\%$

$T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$

| Symbol | Parameter | Condition | Min. | Typ. | Max. | Units |
|----------------------------|-----------------------------------|-------------------------|-------|------|-------|-------|
| V_{DD} , $V_{DDO1/2}$ | 2.5V operating voltage | | 2.375 | 2.5 | 2.625 | V |
| V_{DD} , $V_{DDO1/2}$ | 3.3V operating voltage | | 3.135 | 3.3 | 3.465 | V |
| I_{DD} | Supply current $V_{DD} + V_{DDO}$ | Outputs 50Ω to V_{SS} | | 150 | 185 | mA |

HCSL DC Electrical Characteristics⁽⁵⁾

$V_{DD} = V_{DDO1/2} = 3.3V \pm 5\%$ or $2.5V \pm 5\%$

$V_{DD} = 3.3V \pm 5\%$, $V_{DDO1/2} = 3.3V \pm 5\%$ or $2.5V \pm 5\%$

$T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$. $R_L = 50\Omega$ to V_{SS}

| Symbol | Parameter | Condition | Min. | Typ. | Max. | Units |
|-------------|------------------------|-----------|------|------|------|-------|
| V_{OH} | Output High Voltage | | 660 | 700 | 850 | mV |
| V_{OL} | Output Low Voltage | | -150 | 0 | 27 | mV |
| V_{CROSS} | Crossing Point Voltage | | 250 | 350 | 550 | mV |

LVC MOS (S0, S1) Electrical Characteristics⁽⁵⁾

$V_{DD} = 3.3V \pm 5\%$, or $2.5V \pm 5\%$, $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$.

| Symbol | Parameter | Condition | Min. | Typ. | Max. | Units |
|----------|--------------------|-----------------------------------|------|------|----------------|-------|
| V_{IH} | Input High Voltage | | 2.0 | | $V_{DD} + 0.3$ | V |
| V_{IL} | Input Low Voltage | | -0.3 | | 0.8 | V |
| I_{IH} | Input High Current | $V_{DD} = V_{IN} = 3.465V$ | | | 150 | μA |
| I_{IL} | Input Low Current | $V_{DD} = 3.465V$, $V_{IN} = 0V$ | -150 | | | μA |

Notes:

- Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
- The device is not guaranteed to function outside its operating ratings.
- Package thermal resistance assumes exposed pad is soldered (or equivalent) to the devices most negative potential on the PCB.
- The circuit is designed to meet the AC and DC specifications shown in the above table(s) after thermal equilibrium has been established.

Crystal Characteristics

| Parameter | Condition | Min. | Typ. | Max. | Units |
|------------------------------------|-----------------------|--------------------------------|------|------|----------|
| Mode of Oscillation | 15pF load capacitance | Fundamental, Parallel Resonant | | | |
| Frequency | | | 25 | | MHz |
| Equivalent Series Resistance (ESR) | | | | 50 | Ω |
| Shunt Capacitor, C0 | | | 1 | 7 | pF |
| Correlation Drive Level | | | 10 | 100 | μ W |

AC Electrical Characteristics^(6, 7)

$$V_{DD} = V_{DDO1/2} = 3.3V \pm 5\% \text{ or } 2.5V \pm 5\%$$

$$V_{DD} = 3.3V \pm 5\%, V_{DDO1/2} = 3.3V \pm 5\% \text{ or } 2.5V \pm 5\%$$

$$T_A = -40^\circ\text{C to } +85^\circ\text{C. RL} = 50\Omega \text{ to } V_{SS}$$

| Symbol | Parameter | Condition | Min. | Typ. | Max. | Units |
|----------------------------------|---------------------------------|--|------|-------------------------|-----------------|-----------------|
| F _{OUT} | Output Frequency | | | 25 100 125 200 | | MHz |
| F _{REF} | Crystal Input Frequency | | | 25 | | MHz |
| FIN | Reference Input Frequency | | | 25 | | MHz |
| FIN | FIN Signal Amplitude | Internally AC-coupled | 0.9 | | V _{DD} | V _{PP} |
| T _R /T _F | HCSL Output Rise/Fall Time | 20% - 80% | 150 | 300 | 450 | ps |
| ODC | Output Duty Cycle | | 48 | 50 | 52 | % |
| T _{SKEW} | Output-to-Output Skew | Note 7 | | | 45 | ps |
| T _{LOCK} | PLL Lock Time | | | | 20 | ms |
| T _{JIT} (\emptyset) | RMS Phase Jitter ⁽⁸⁾ | 100MHz Integration Range (1.5MHz – 10MHz) | | 320 | | fs |
| | Cycle-to-Cycle Jitter | | | | 30 | ps, peak |

Notes:

- All phase noise measurements were taken with an Agilent 5052B phase noise system.
- Defined as skew between outputs at the same supply voltage and with equal load conditions; measured at the output differential crossing points.
- Measured using 25MHz crystal as the input reference source. If using an external reference input, use a low phase noise source. With an external reference, the phase noise will follow the input source phase noise up to about 1MHz.

Spread Spectrum Characteristics

| Parameter | Condition | Min. | Typ. | Max. | Units |
|--------------------------------------|-------------------|------------------|-------------|------------------|-------|
| Modulation Rate ⁽⁹⁾ | | | 31.6 | | kHz |
| Modulation Magnitude ⁽¹⁰⁾ | Setting is -0.25% | -0.073 to -0.265 | 0 to -0.250 | +0.031 to -0.375 | % |
| | Setting is -0.50% | -0.136 to -0.383 | 0 to -0.500 | +0.078 to -0.589 | % |

Notes:

- The modulation rate is created from the crystal frequency, divided by 792.
- The typical modulation makes the output frequency sweep between the target frequency (0%) and the down-spread value (-0.25% or -0.5%). There is process variation on the modulation magnitude and the smallest and largest possible modulation magnitude sweep ranges are listed in the table.

Truth Tables

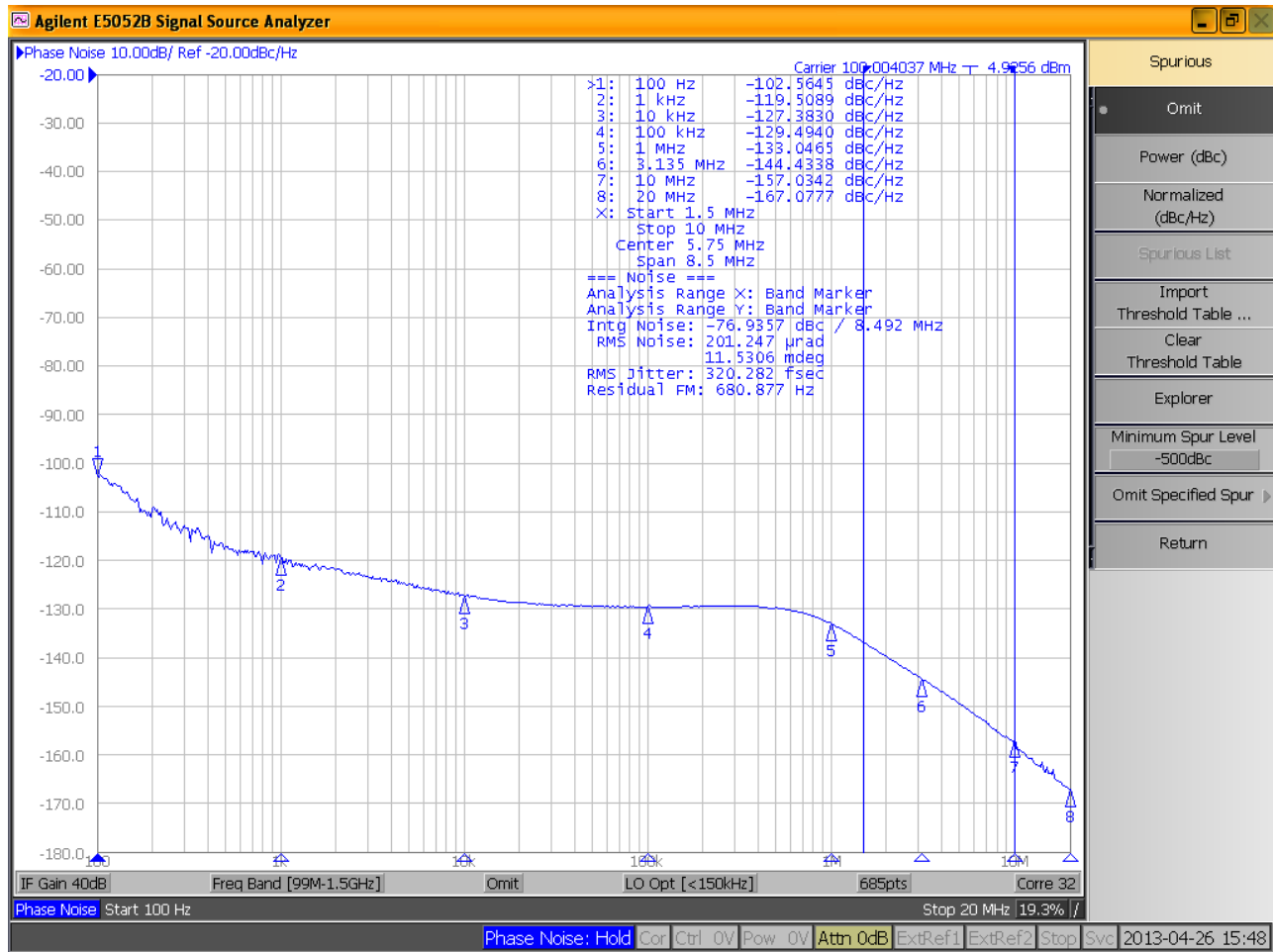
| S1 | S0 | OUTPUT |
|----|----|--------|
| 0 | 0 | 25MHz |
| 0 | 1 | 100MHz |
| 1 | 0 | 125MHz |
| 1 | 1 | 200MHz |

| SS1 ⁽¹¹⁾ | SS0 ⁽¹¹⁾ | Spread Type | Spread |
|---------------------|---------------------|---------------|-----------|
| 0 | 0 | Spread is OFF | No Spread |
| 0 | 1 | Down Spread | -0.25% |
| 1 | 0 | Spread is OFF | No Spread |
| 1 | 1 | Down Spread | -0.50% |

Note:

11. SS0 is turning ON/OFF the spread spectrum modulation and SS1 is selecting the spread magnitude.

Phase Noise Plot



Phase Noise Plot: 100MHz, 1.5MHz – 10MHz 320fs

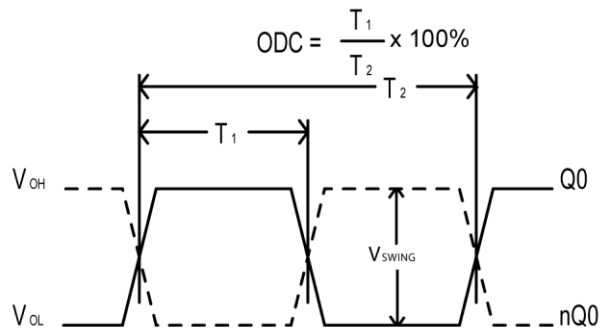


Figure 1. Duty Cycle Timing

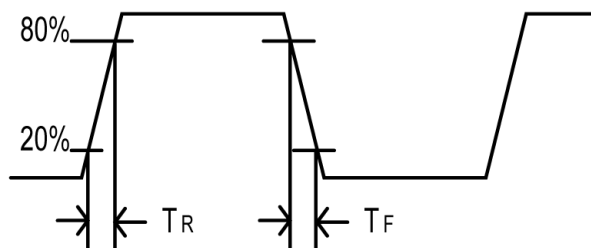


Figure 2. All Outputs Rise/Fall Times

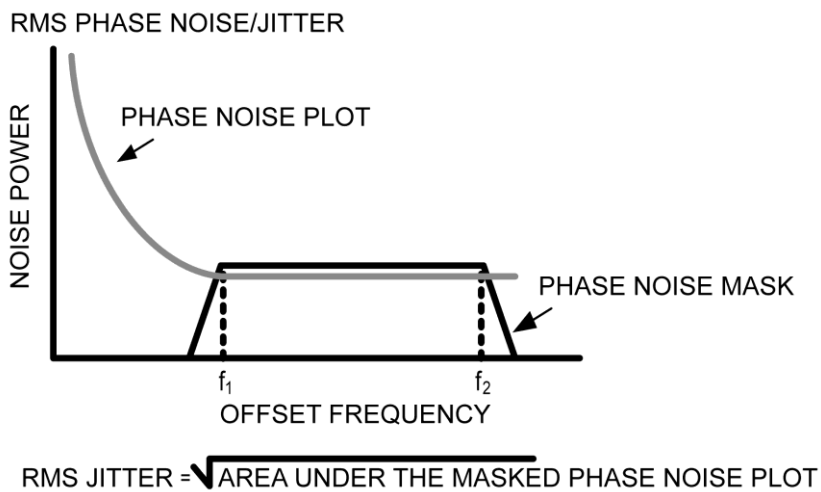


Figure 3. RMS Phase/Noise Jitter

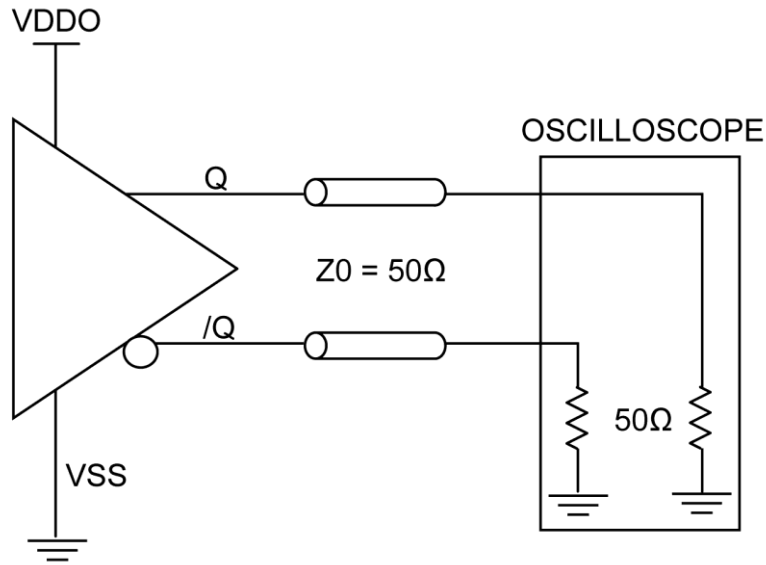


Figure 4. HCSL Output Load and Test Circuit

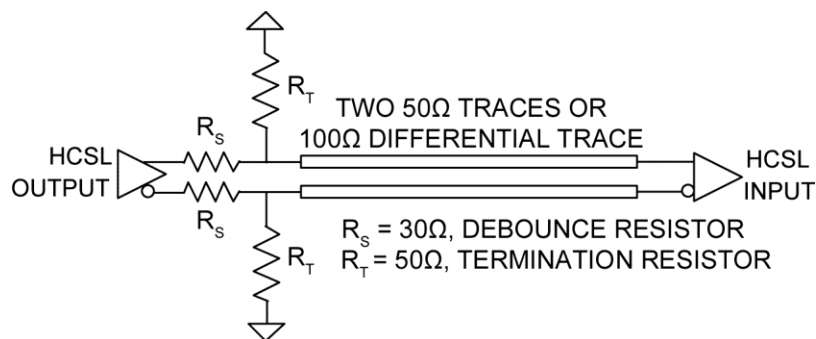


Figure 5. HCSL Recommended Application Termination (Source Terminated)

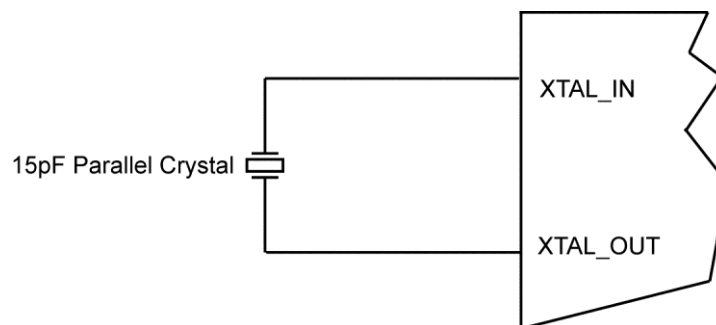


Figure 6. Crystal Input Interface

Application Information

Crystal Layout

Keep the layers under the crystal as open as possible and do not place switching signals or noisy supplies under the crystal. Crystal load capacitance is built inside the die so no external capacitance is needed. See the *Selecting a Quartz Crystal for the Clockworks Flex / Family of Precision Synthesizers* application note for more details.

Contact Micrel's TCG applications group at: tcghelp@micrel.com if you need help selecting a suitable crystal for your application.

Power Supply Decoupling

Place the smallest value decoupling capacitor (4.7nF above) between the VDD and VSS pins, as close as possible to those pins and at the same side of the PCB as the IC. The shorter the physical path from VDD to capacitor and back from capacitor to VSS, the more effective the decoupling. Use one 4.7nF capacitor for each VDD pin on the PL607041.

The impedance value of the Ferrite Bead (FB) needs to be between 240Ω and 600Ω with a saturation current ≥150mA.

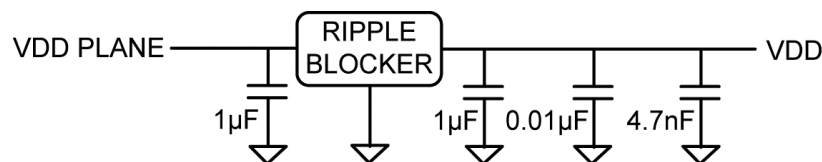
VDDO1 and VDDO2 pins connect directly to the VDD Plane. All VDD pins on the PL607041 connect to VDD after the power supply filter.

HCSL Outputs

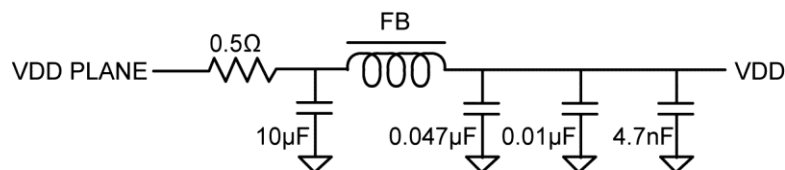
HCSL outputs are to be terminated with 50Ω to Vss. For best performance load all outputs. If you want to AC-couple or change the termination, contact Micrel's application group: tcghelp@micrel.com (see Figure 5).

Power Supply Filtering Recommendations

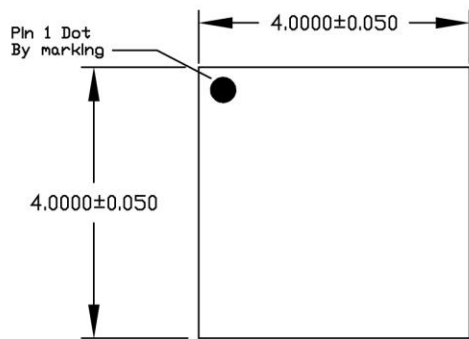
Preferred filter, using Micrel's MIC94300 or MIC94310 Ripple Blocker™:



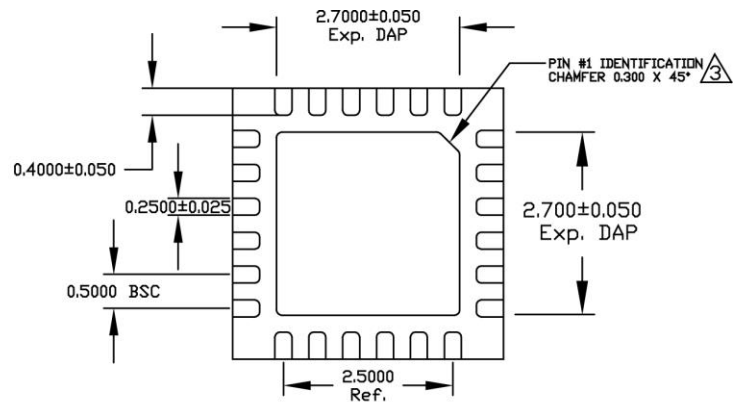
Alternative, traditional filter, using a ferrite bead:



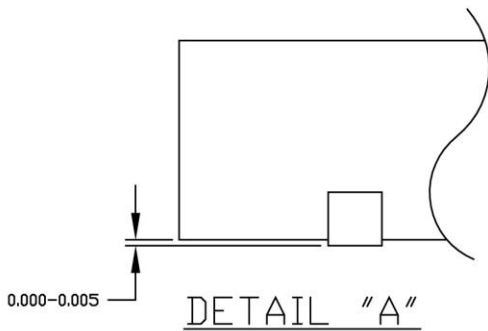
Package Information⁽¹²⁾



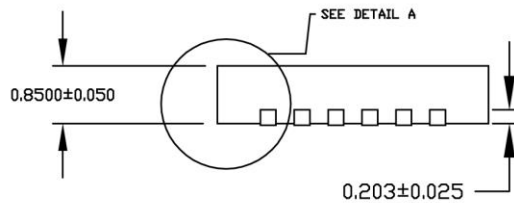
TOP VIEW



BOTTOM VIEW



DETAIL "A"



SIDE VIEW

NOTE:

1. ALL DIMENSIONS ARE IN MILLIMETERS (mm).
2. THE PIN#1 IDENTIFIER MUST EXIST ON THE TOP SURFACE OF PACKAGE BY USING IDENTIFICATION MARK OR OTHER FEATURE OF PACKAGE BODY.
3. CHAMFER STYLE PIN 1 IDENTIFIER ON BOTTOM SIDE

24-Pin QFN

Note:

12. Package information is correct as of the publication date. For updates and most current information, go to www.micrel.com.

MICREL, INC. 2180 FORTUNE DRIVE SAN JOSE, CA 95131 USATEL +1 (408) 944-0800 FAX +1 (408) 474-1000 WEB <http://www.micrel.com>

Micrel makes no representations or warranties with respect to the accuracy or completeness of the information furnished in this data sheet. This information is not intended as a warranty and Micrel does not assume responsibility for its use. Micrel reserves the right to change circuitry, specifications and descriptions at any time without notice. No license, whether express, implied, arising by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Micrel's terms and conditions of sale for such products, Micrel assumes no liability whatsoever, and Micrel disclaims any express or implied warranty relating to the sale and/or use of Micrel products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right.

Micrel Products are not designed or authorized for use as components in life support appliances, devices or systems where malfunction of a product can reasonably be expected to result in personal injury. Life support devices or systems are devices or systems that (a) are intended for surgical implant into the body or (b) support or sustain life, and whose failure to perform can be reasonably expected to result in a significant injury to the user. A Purchaser's use or sale of Micrel Products for use in life support appliances, devices or systems is a Purchaser's own risk and Purchaser agrees to fully indemnify Micrel for any damages resulting from such use or sale.

© 2014 Micrel, Incorporated.

OUR CERTIFICATE

DiGi provide top-quality products and perfect service for customer worldwide through standardization, technological innovation and continuous improvement. DiGi through third-party certification, we stricly control the quality of products and services. Welcome your RFQ to

Email: Info@DiGi-Electronics.com



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.